

DECLARATION FOR PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name,

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

COMPOSITIONS AND METHOD FOR REMOVING PHOTORESIST AND/OR RESIST RESIDUE AT PRESSURES

RANGING FROM AMBIENT TO SUPERCRITICAL												
the specification of which (check one) is attached hereto or was filed on July 16, 2003 as Application No. 10/620,895 and was amended on (if applicable). I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above. I acknowledge the duty to disclose all information which is material to patentability as defined in 37 CFR § 1.56.												
								or inventor's certithan the United S	ificate, or § 365(a) of any PCT States, listed below and have a	U.S.C. § 119(a)-(d) or § 365(b) of any foreign application which designated at leastless identified below any foreign application for parapplication on which priority is claimed:	st one coun	try other
								Prior Foreign Application(s)			Priority Yes	Claimed <u>No</u>
Number	Country	Day/Month/Year Filed										
Number	Country	Day/Month/Year Filed										
I hereby claim the	e benefit under 35 U.S.C. § 11	9(3) of any United States provisional application	(s) below:									
Application Numb	ber	Filing Date		-								
Application Numb	ber	Filing Date		-								
Application Numb	ber	Filing Date		-								
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I hereby claim the benefit under 35 U.S.C. § 120 of any United States application(s), or § 365(c) of any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of 35 U.S.C. § 112, I acknowledge the duty to disclose all information which is material to patentability as defined in 37 CFR § 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application:

10/197,384 Application Number	July 17, 2002 Filing Date	Pending Status: Patented, Pending, Abandoned
Application Number	Filing Date	Status: Patented, Pending, Abandoned
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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment or both, under 18 U.S.C. § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of sole or first inventor <u>Al</u>	kshey Sehgal	
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